

74HC05

Hex inverter with open-drain outputs

Rev. 02 — 18 June 2009

Product data sheet

1. General description

The 74HC05 is a high-speed Si-gate CMOS device that complies with JEDEC standard no. 7A.

The 74HC05 contains six inverters. The outputs of the 74HC05 are open-drain and can be connected to other open-drain outputs to implement active-LOW wired-OR or active-HIGH wired-AND functions. The open-drain outputs require pull-up resistors to perform correctly.

2. Features

- Wide operating voltage 2.0 V to 6.0 V
- Input levels:
 - ◆ For 74HC05: CMOS level
- Latch-up performance exceeds 100 mA per JESD 78 Class II level A
- ESD protection:
 - ◆ HBM JESD22-A114E exceeds 2000 V
 - ◆ CDM JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ and from $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | |
|-------------|---|----------|---|----------|
| | Temperature range | Name | Description | Version |
| 74HC05D | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 |
| 74HC05PW | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |
| 74HC05BQ | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85\text{ mm}$ | SOT762-1 |

4. Functional diagram

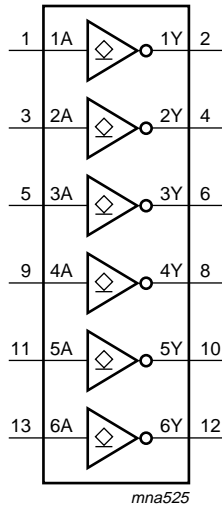


Fig 1. Logic symbol

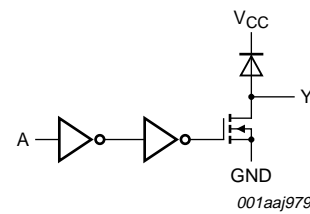


Fig 2. Logic diagram (one gate)

5. Pinning information

5.1 Pinning

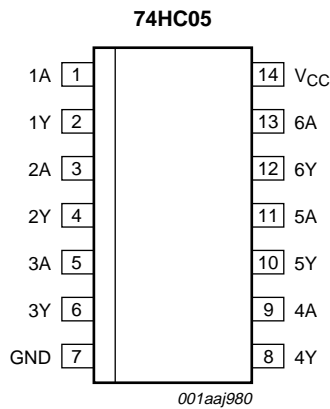
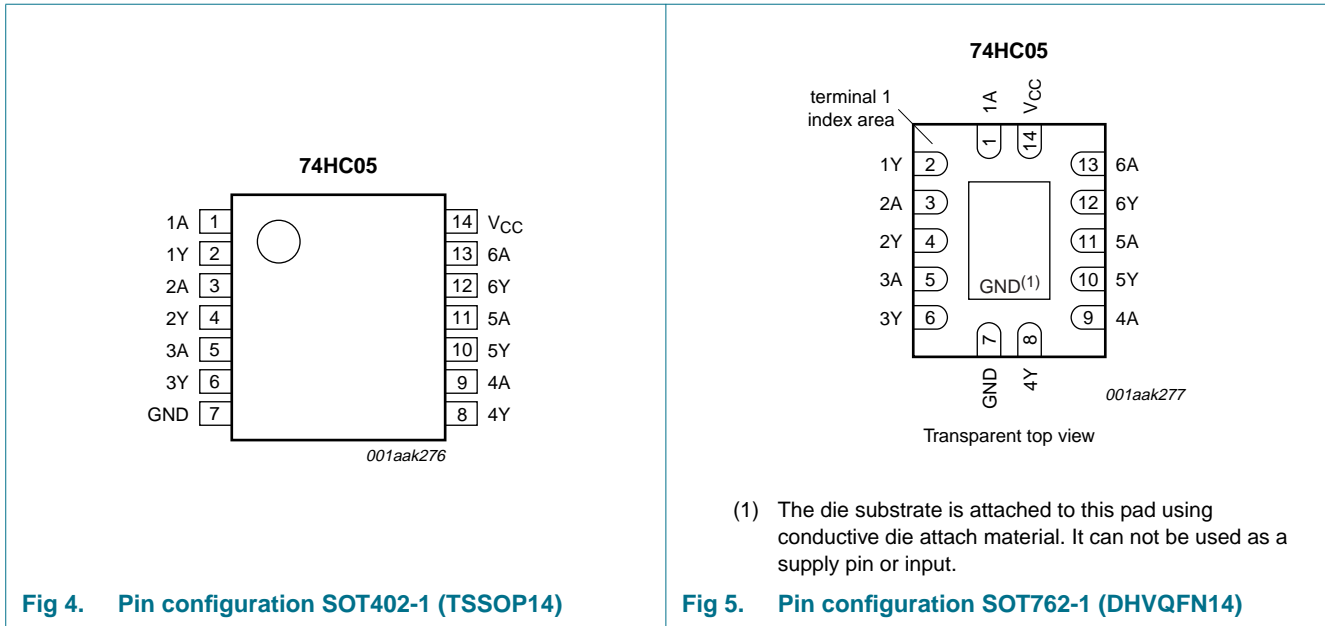


Fig 3. Pin configuration SOT108-1 (SO14)



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|--------------------|----------------|
| 1A to 6A | 1, 3, 5, 9, 11, 13 | data input |
| 1Y to 6Y | 2, 4, 6, 8, 10, 12 | data output |
| GND | 7 | ground (0 V) |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function table^[1]

| Input | Output |
|-------|--------|
| nA | nY |
| L | Z |
| H | L |

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------|-------------------------|---|----------|-------------------------|------|
| V _{CC} | supply voltage | | -0.5 | +7 | V |
| I _{IK} | input clamping current | V _I < -0.5 V or V _I > V _{CC} + 0.5 V | [1] - | 20 | mA |
| I _{OK} | output clamping current | V _O < -0.5 V or V _O > V _{CC} + 0.5 V | [1] - | 20 | mA |
| V _O | output voltage | | [1] -0.5 | V _{CC} + 0.5 V | V |

Table 4. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|--------------------------------|-------|------|------|
| I_O | output current | $V_O < V_{CC} + 0.5 \text{ V}$ | - | 25 | mA |
| I_{CC} | supply current | | - | 50 | mA |
| I_{GND} | ground current | | -50 | - | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | | [2] - | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- [2] For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For TSSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------------|--------------------------|-----|------|----------|------|
| V_{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | V |
| V_I | input voltage | | 0 | - | V_{CC} | V |
| V_O | output voltage | | 0 | - | V_{CC} | V |
| T_{amb} | ambient temperature | | -40 | - | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.0 \text{ V}$ | - | - | 625 | ns/V |
| | | $V_{CC} = 4.5 \text{ V}$ | - | 1.67 | 139 | ns/V |
| | | $V_{CC} = 6.0 \text{ V}$ | - | - | 83 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|--|--------------------------|--|-------|------|------|------------------|------|-------------------|------|------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| V_{IH} | HIGH-level input voltage | $V_{CC} = 2.0 \text{ V}$ | 1.5 | 1.2 | - | 1.5 | - | 1.5 | - | V |
| | | $V_{CC} = 4.5 \text{ V}$ | 3.15 | 2.4 | - | 3.15 | - | 3.15 | - | V |
| | | $V_{CC} = 6.0 \text{ V}$ | 4.2 | 3.2 | - | 4.2 | - | 4.2 | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 2.0 \text{ V}$ | - | 0.8 | 0.5 | - | 0.5 | - | 0.5 | V |
| | | $V_{CC} = 4.5 \text{ V}$ | - | 2.1 | 1.35 | - | 1.35 | - | 1.35 | V |
| | | $V_{CC} = 6.0 \text{ V}$ | - | 2.8 | 1.8 | - | 1.8 | - | 1.8 | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | | | | | |
| | | $I_O = 20 \mu\text{A}; V_{CC} = 2.0 \text{ V}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 20 \mu\text{A}; V_{CC} = 4.5 \text{ V}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 20 \mu\text{A}; V_{CC} = 6.0 \text{ V}$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| $I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$ | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V | | |

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|----------|--------------------------|--|-------|-----|-----|------------------|-----|-------------------|-----|---------|
| | | | Min | Typ | Max | Min | Max | Min | Max | |
| I_I | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0$ V | - | - | 0.1 | - | 1 | - | 1 | μ A |
| I_{OZ} | OFF-state output current | per input pin; $V_I = V_{IL}$; $V_O = V_{CC}$ or GND; other inputs at V_{CC} or GND; $V_{CC} = 6.0$ V; $I_O = 0$ A | - | - | 0.5 | - | 5.0 | - | 10 | μ A |
| I_{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V | - | - | 2.0 | - | 20 | - | 40 | μ A |
| C_I | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

10. Dynamic characteristics

Table 7. Dynamic characteristicsGND = 0 V; for test circuit see [Figure 7](#).

| Symbol | Parameter | Conditions | 25 °C | | | -40 °C to +125 °C | | Unit |
|-----------|------------------------------------|---|-------|-----|-----|-------------------|--------------|------|
| | | | Min | Typ | Max | Max (85 °C) | Max (125 °C) | |
| t_{PLZ} | LOW to OFF-state propagation delay | nA to nY; see Figure 6 $V_{CC} = 2.0$ V | - | 20 | 90 | 115 | 135 | ns |
| | | $V_{CC} = 4.5$ V | - | 11 | 18 | 23 | 27 | ns |
| | | $V_{CC} = 6.0$ V | - | 10 | 15 | 20 | 23 | ns |
| t_{PZL} | OFF-state to LOW propagation delay | nA to nY; see Figure 6 $V_{CC} = 2.0$ V | - | 22 | 90 | 115 | 135 | ns |
| | | $V_{CC} = 4.5$ V | - | 9 | 18 | 23 | 27 | ns |
| | | $V_{CC} = 6.0$ V | - | 8 | 15 | 20 | 23 | ns |
| t_{THL} | HIGH to LOW output transition time | see Figure 6 $V_{CC} = 2.0$ V | - | 18 | 75 | 95 | 110 | ns |
| | | $V_{CC} = 4.5$ V | - | 6 | 15 | 19 | 22 | ns |
| | | $V_{CC} = 6.0$ V | - | 5 | 13 | 16 | 19 | ns |
| C_{PD} | power dissipation capacitance | per inverter; $V_I =$ GND to V_{CC} ; $V_{CC} = 5.0$ V | [1] | - | 4 | - | - | pF |

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

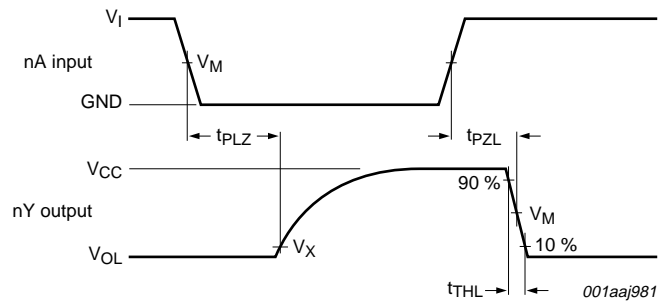
$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(0.5 \times C_L \times V_O^2 \times f_o) \text{ where:}$$

 f_i = input frequency in MHz; f_o = output frequency in MHz; V_O = output voltage in V (output HIGH); V_{CC} = supply voltage in V;

N = number of inputs switching;

 R_L = load resistance in M Ω ; C_L = load capacitance in pF;

11. Waveforms



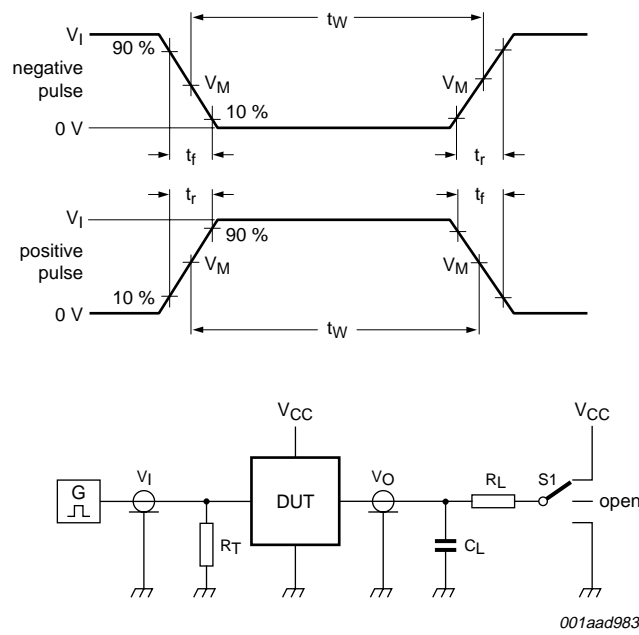
Measurement points are given in [Table 8](#).

V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 6. The input nA to output nY propagation delays and output transition times

Table 8. Measurement points

| Input | Output | |
|-------------|-------------|-------------|
| V_M | V_M | V_X |
| $0.5V_{CC}$ | $0.5V_{CC}$ | $0.1V_{CC}$ |



Test data is given in [Table 9](#).

Definitions test circuit:

R_T = termination resistance should be equal to output impedance Z_o of the pulse generator.

C_L = load capacitance including jig and probe capacitance.

R_L = Load resistance.

Fig 7. Test circuit for measuring switching times

Table 9. Test data

| Input | | Load | | S1 position |
|----------|------------|-------|-------|--------------------|
| V_I | t_r, t_f | C_L | R_L | t_{pZL}, t_{pLZ} |
| V_{CC} | 6 ns | 50 pF | 1 kΩ | V_{CC} |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

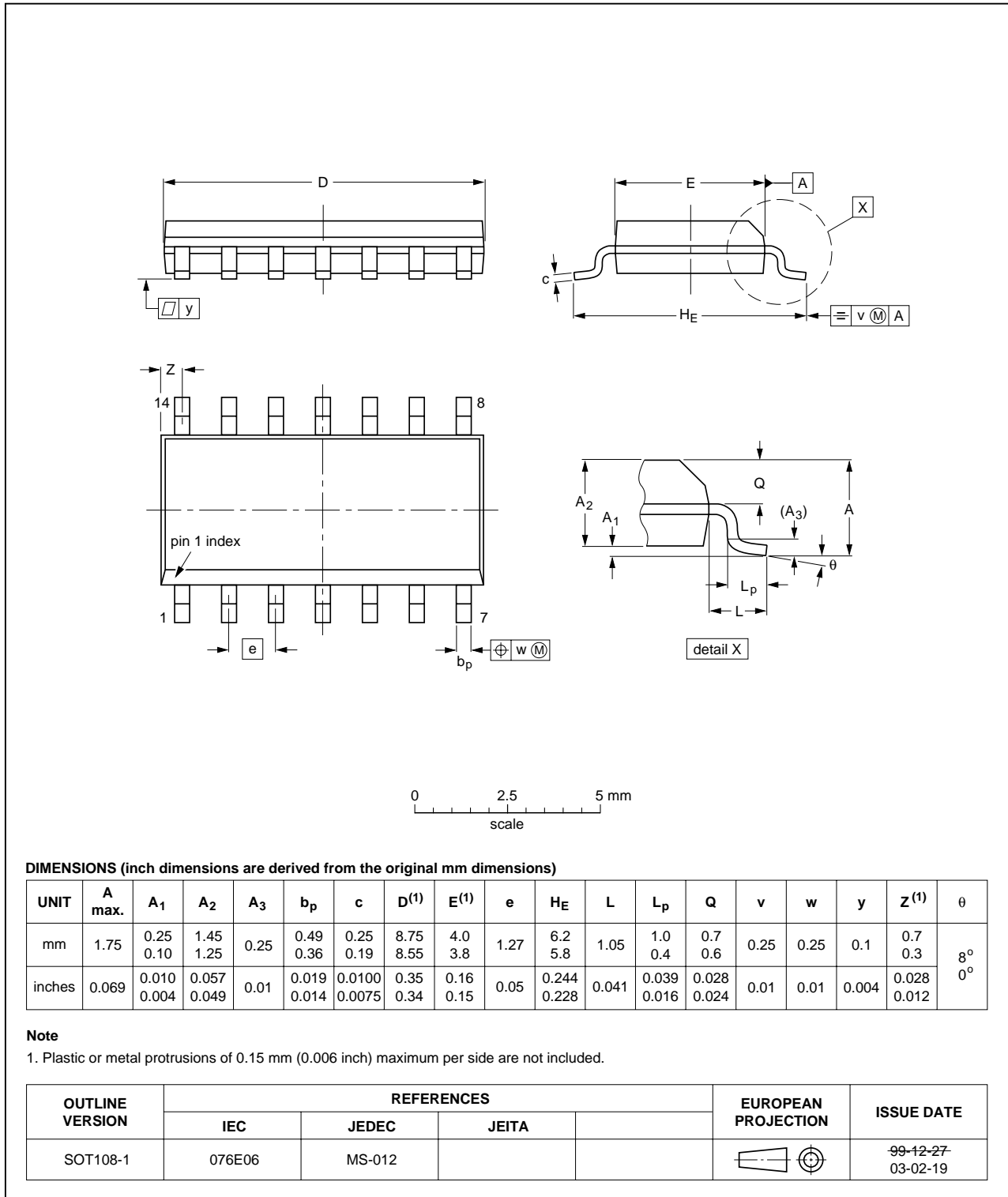


Fig 8. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

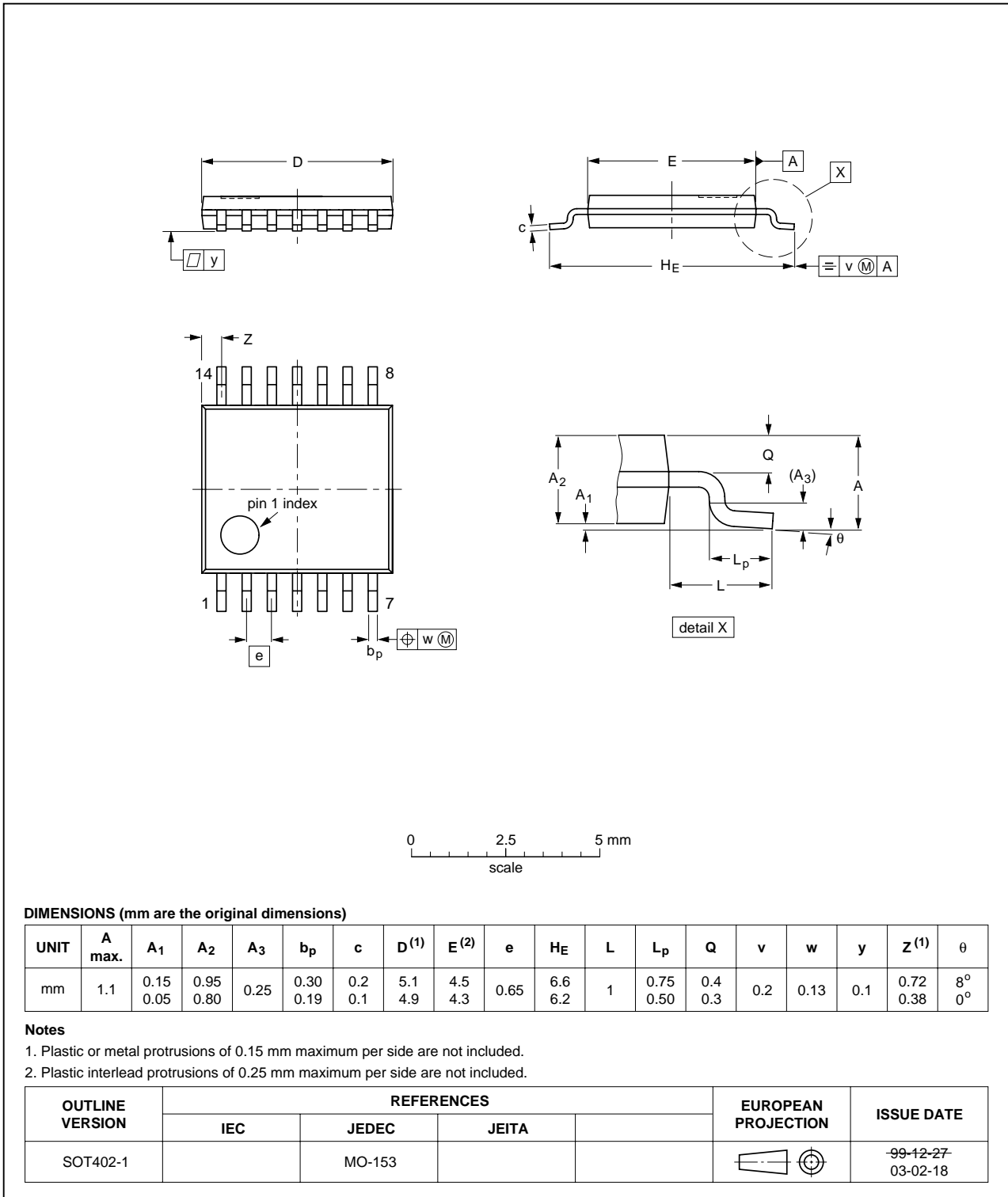


Fig 9. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

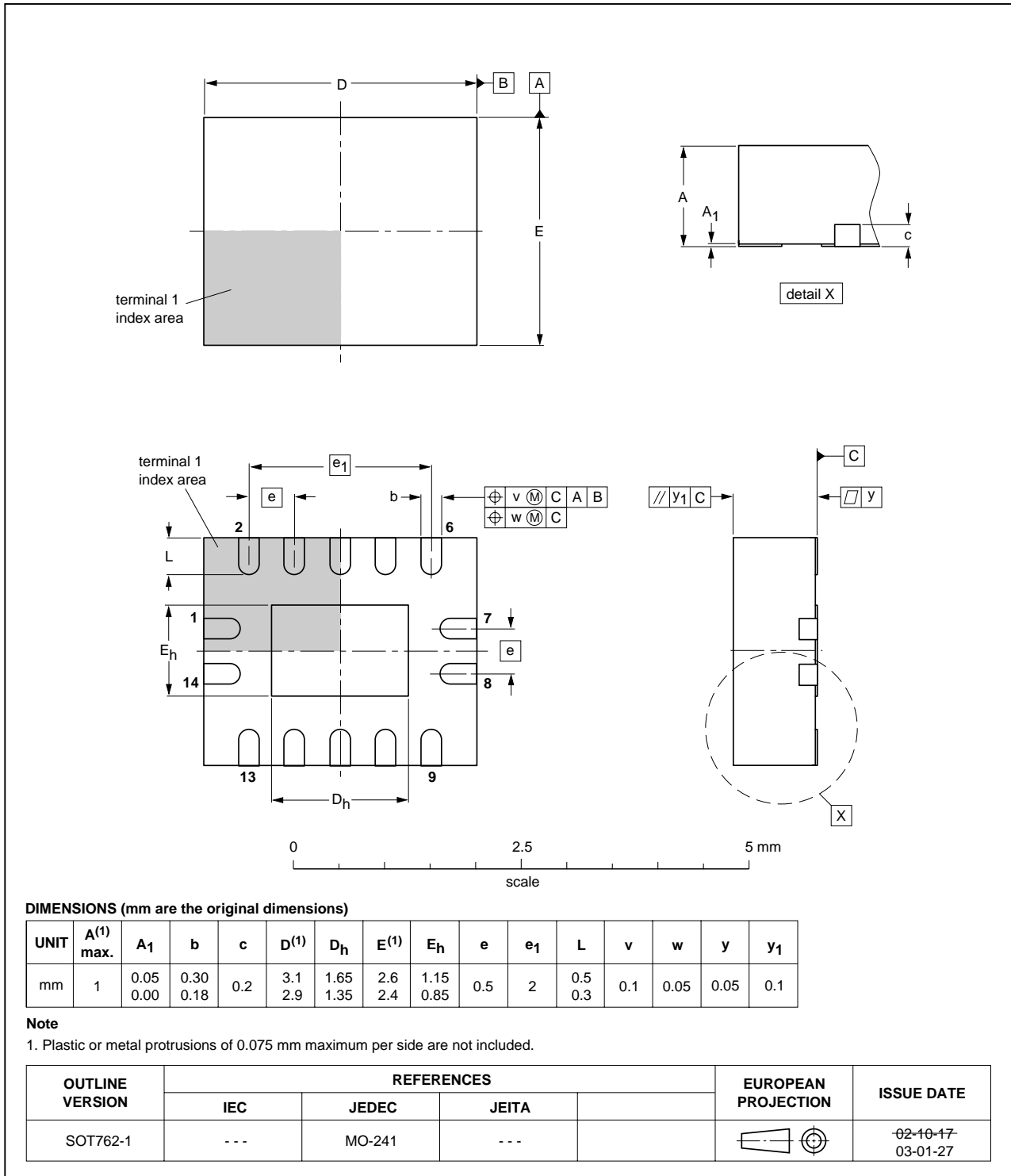


Fig 10. Package outline SOT762-1 (DHVQFN14)

13. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |

14. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|---|--------------------|---------------|------------|
| 74HC05_2 | 20090618 | Product data sheet | - | 74HC05_1 |
| Modifications: | • Added type numbers 74HC05PW (TSSOP14 package) and 74HC05BQ (DHVQFN14 package) | | | |
| 74HC05_1 | 20090427 | Product data sheet | - | - |

15. Legal information

15.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

15.3 Disclaimers

General — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by Nexperia. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: salesaddresses@nexperia.com

17. Contents

| | | |
|-----------|---|-----------|
| 1 | General description | 1 |
| 2 | Features | 1 |
| 3 | Ordering information | 1 |
| 4 | Functional diagram | 2 |
| 5 | Pinning information | 2 |
| 5.1 | Pinning | 2 |
| 5.2 | Pin description | 3 |
| 6 | Functional description | 3 |
| 7 | Limiting values | 3 |
| 8 | Recommended operating conditions | 4 |
| 9 | Static characteristics | 4 |
| 10 | Dynamic characteristics | 5 |
| 11 | Waveforms | 6 |
| 12 | Package outline | 8 |
| 13 | Abbreviations | 11 |
| 14 | Revision history | 11 |
| 15 | Legal information | 12 |
| 15.1 | Data sheet status | 12 |
| 15.2 | Definitions | 12 |
| 15.3 | Disclaimers | 12 |
| 15.4 | Trademarks | 12 |
| 16 | Contact information | 12 |
| 17 | Contents | 13 |